

Supply Chain Explorer

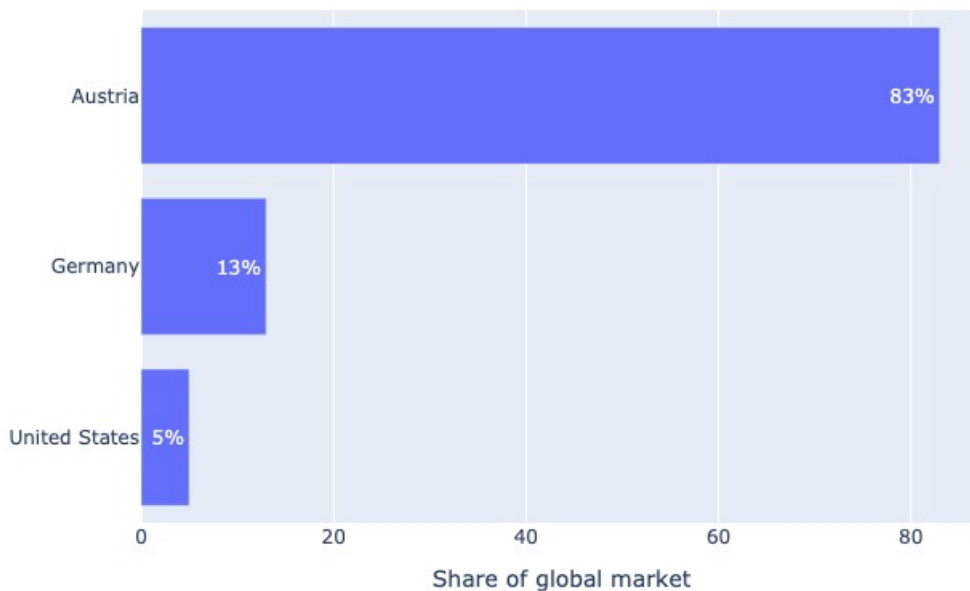
By the Emerging Technology Observatory

This is an export from the ETO Supply Chain Explorer, available at: <https://TBD.cset.tech> You can see the web version of this content at <https://TBD.cset.tech/?filter-choose=input-resource&input-resource=N10>.

Wafer bonding and aligning tools

Wafer bonders and aligners join silicon wafers. In this visualization, these tools are included in the wafer manufacturing process preceding chip fabrication, but they may also be used after chips are fabricated in the wafers. Austria, Germany, and the United States produce this equipment

Country provision



Other providers:

- China (mainland) (negligible market share)

Notable supplier companies

- EV Group - Austria
- Neutronix - United States
- SMEE (negligible market share) - China (mainland)
- SUSS MicroTec - Germany